

RS2AF THRU RS2MF

Fast Recovery Rectifiers



Voltage: 50~1000 Volts

Current: 2 Amperes

Package: SMAF

Features

- NH'S Fast Recovery Rectifiers Chip Technology
- Low Switching Loss For High Efficiency
- Low Leakage Current For High Reliability
- Fast Switching Speed

Mechanical Data

- **Case:** Molded With UL-94 Class V-0 Recognized, RoHS-Compliant
- **Polarity:** Look At The Diagram And Polarity On The Right
- **Terminals:** Tin Plated Leads, Solderable Per J-STD-002 And JESD22-B102

Typical Applications

- Switch Mode Power Supplies (SMPS)
- Fast Chargers
- LED Driver And Monitor Lighting
- Automotive Electronics And Charging Posts

Diagram:



Polarity:



Single Phase, Half Wave, 60Hz, Resistive Or Inductive Load. For Capacitive Load, Derate Current By 20%

Maximum Ratings (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	RS2 AF	RS2 BF	RS2 DF	RS2 GF	RS2 JF	RS2 KF	RS2 MF	Unit
Maximum Repetitive Peak Reverse Voltage		V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V_{DC}	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current		$I_{F(AV)}$	2							A
Peak Forward Surge Current	8.3ms Single Half Sine-wave Superimposed On Rate Load	I_{FSM}	60							A
Current Squared Time	$t < 8.3ms$	I^2t	14.9							A ² sec

Electrical Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	RS2 AF	RS2 BF	RS2 DF	RS2 GF	RS2 JF	RS2 KF	RS2 MF	Unit
Maximum Instantaneous Forward Voltage	$I_F = 2.0 A$	V_F	1.30							V
Maximum DC Reverse Current at Rated DC Blocking Voltage	Ta=25°C, $V_R = V_{RRM}$ Ta=125°C, $V_R = V_{RRM} * 80\%$	I_{RRM}	5 200							uA uA
Typical Junction Capacitance	4 V, 1MHz	C_J	18			11				pF
Maximum Reverse Recovery Time	IF=0.5A, IR=1.0A, IRR=0.25A	T_{rr}	150			250		500		nS

Thermal Characteristics (Ta=25°C Unless Otherwise Specified)

Parameter	Test Conditions	Symbol	RS2 AF	RS2 BF	RS2 DF	RS2 GF	RS2 JF	RS2 KF	RS2 MF	Unit
Operating Junction Temperature Range		T _J	-55~150							℃
Storage Temperature Range		T _{STD}	-55~150							
Thermal Resistance Junction To Ambient With Steady-State	Still Air Environment With Ta=25℃	R _{θJA}	65.0							℃/W
Thermal Resistance Junction-Case With Steady-State	Device Mounted On 1 in2 FR-4 Board With 2oz. Copper	R _{θJC}	18.0							

Notes: 1. Pulse Test: 300 Us Pulse Width, 1% Duty Cycle

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Typical Characteristics Curves

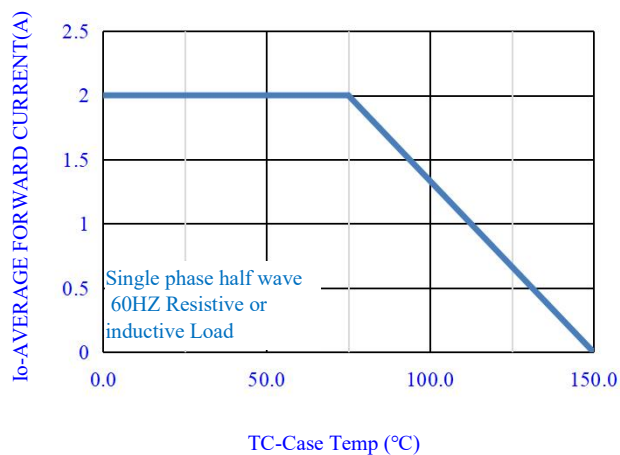


Fig.1-FORWARD CURRENT DERATING CURVE

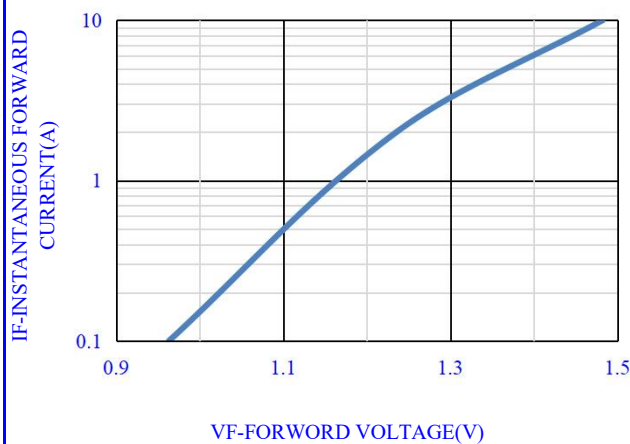


Fig.2- TYPICAL INSTANTANEOUS FORWARD

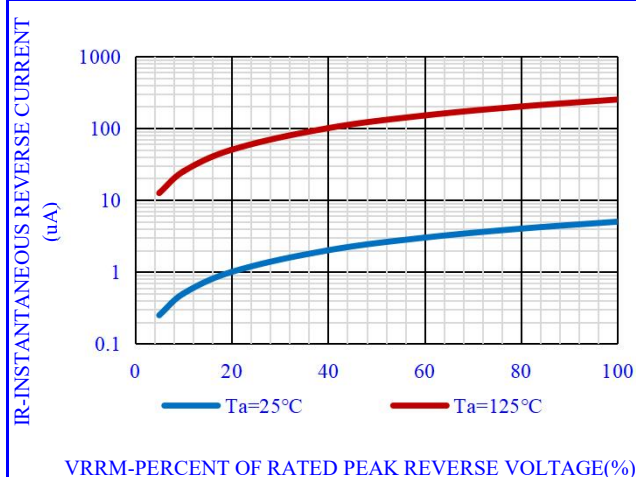


Fig.3- TYPICAL REVERSE CHARACTERISTICS

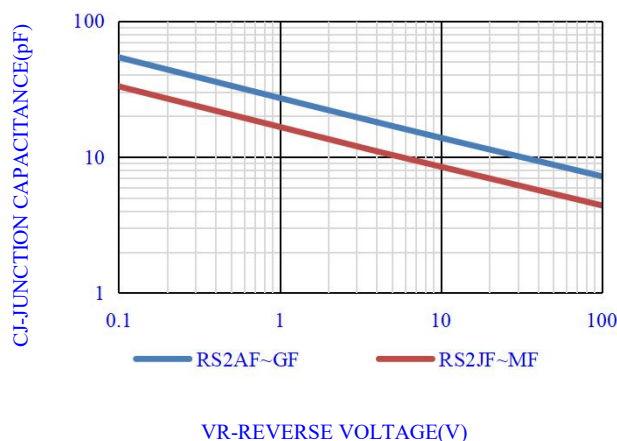


Fig.4- TYPICAL JUNCTION CAPACITANCE

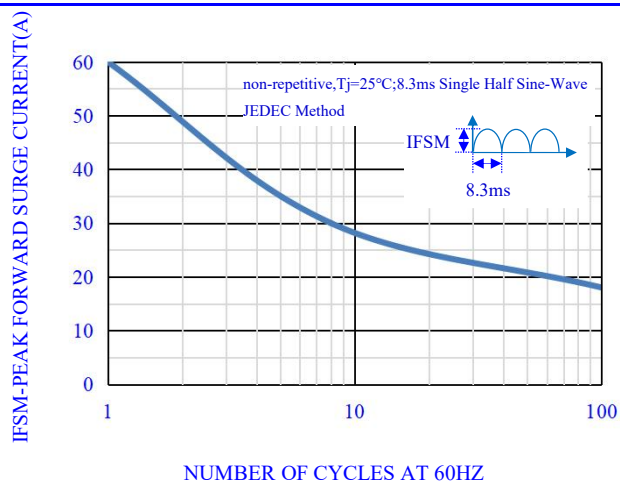


Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

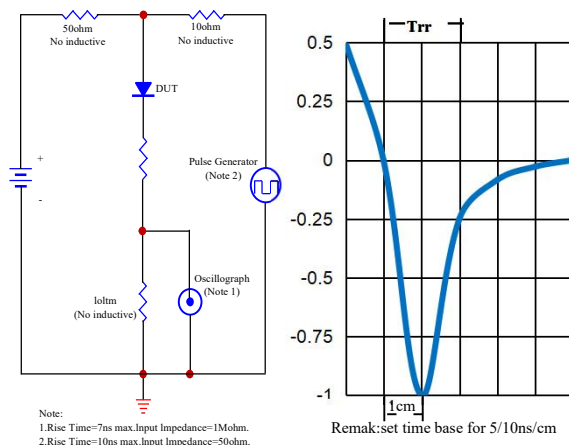
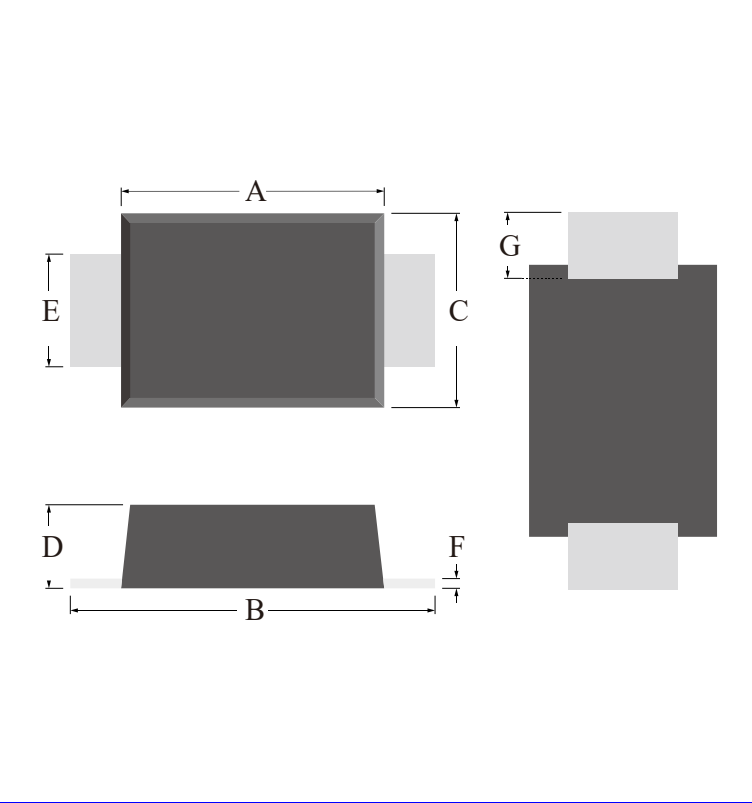


Fig.6-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT

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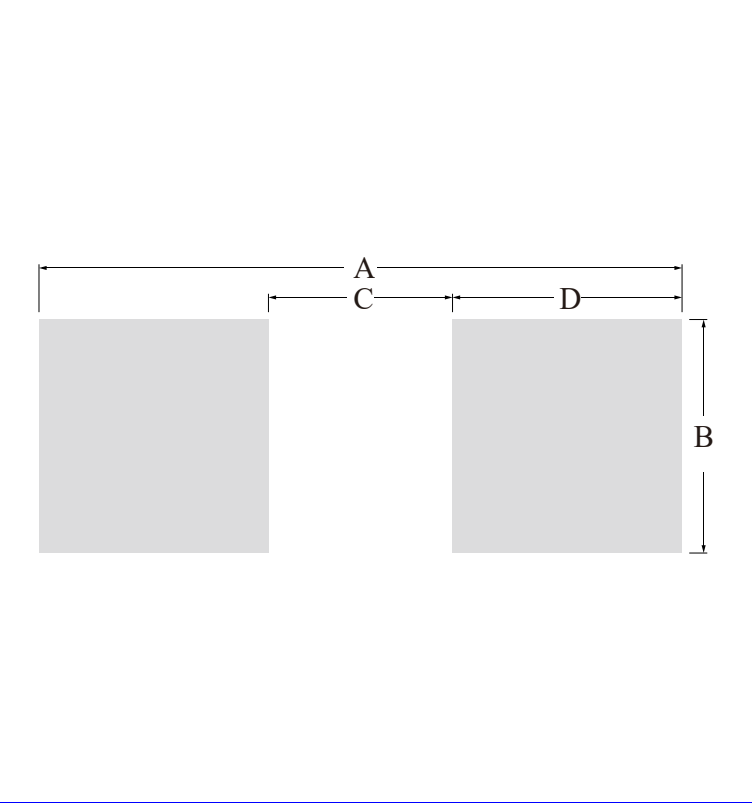
OUTLINE DRAWINGS



SMAF

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	3.20	-	3.80	0.1260	-	0.1496
B	4.40	-	5.30	0.1732	-	0.2087
C	2.30	-	2.70	0.0906	-	0.1063
D	0.95	-	1.20	0.0374	-	0.0472
E	1.30	-	1.60	0.0512	-	0.0630
F	0.08	-	0.17	0.0031	-	0.0067
G	0.50	-	1.20	0.0197	-	0.0472

RECOMMEDNED LAYOUT DRAWINGS



SMAF

OUTLINE DIMENSIONS						
Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	-	5.30	-	-	0.2087	-
B	-	2.06	-	-	0.0811	-
C	-	1.66	-	-	0.0654	-
D	-	2.07	-	-	0.0815	-

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MARKING

MARKING INSTRUCTION



NH=Niuhan Trademark
FF=Product Line Code,According To Actual Changes
YWW=Date Code,According To Actual Changes
RS2xx=Model,xx=AF,BF,DF,GF,JF,KF,MF
White band denotes cathode

PACKING INFORMATION

Package Type	Package Code	Product Weight Approx(g/Pcs)	Package Method	Quantity (Pcs/Min. Pack.)	Quantity (Pcs/Inner Box)	Quantity (Pcs/Carton)
SMAF	P1	0.026	13" Reel	5000	10000	80000
SMAF	P1	0.026	13" Reel	5000	10000	100000

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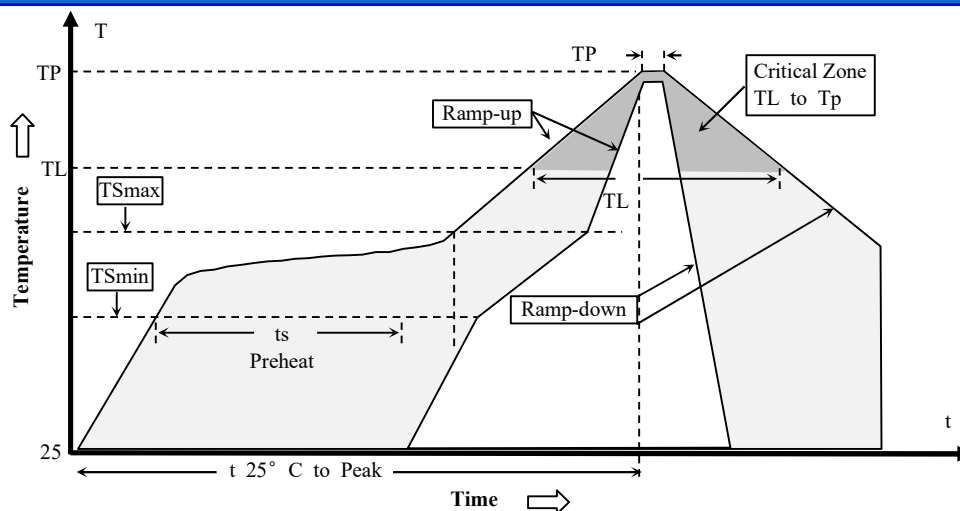
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (T _{smax} to T _p)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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